Chapter 2 Single-node Architecture

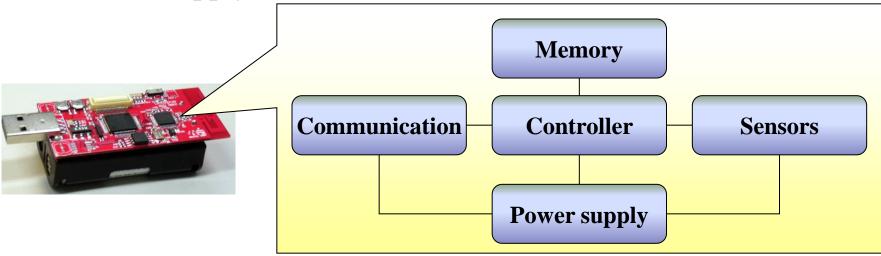
Outline

- > 2.1. Sensor Node Architecture
- > 2.2. Introduction of Sensor Hardware Platform
- ▶ 2.3. Energy Consumption of Sensor Node
- 2.4. Network Architecture
- 2.5. Challenges of Sensor Nodes
- > 2.6. Summary

2.1. Sensor Node Architecture

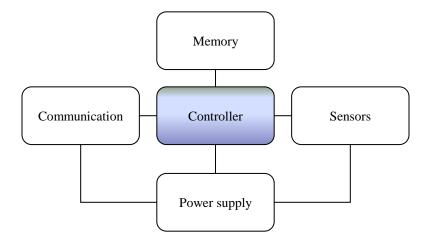
Main Architecture of Sensor Node

- The main architecture of sensor node includes following components:
 - Controller module
 - Memory module
 - Communication module
 - Sensing modules
 - Power supply module



Main Components of a Sensor Node : Controller module

- Main options:
 - MCUs (Microcontrollers)
 - The processor for general purposes
 - Optimized for embedded applications
 - Low energy consumption
 - DSPs (Digital Signal Processors)
 - Optimized for signal processing
 - Low cost
 - High processing speed
 - Not suitable for sensor node
 - FPGAs (Field Programmable Gate Arrays)
 - Suitable for product development and testing
 - Cost higher than DSPs
 - High energy consumption
 - Processing speed lower than ASICs
 - ASICs (Application-Specific Integrated Circuits)
 - Only when peak performance is needed
 - For special purpose
 - Not flexable

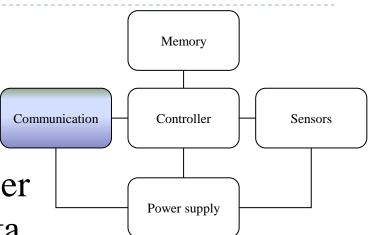


Main Components of a Sensor Node : Controller module

• Example of microcontrollers are recently used in Senor Node

- > ATMega128L, Atmel
 - 8-bit controller
 - ▶ 128KB program memory (flash)
 - 512KB additional data flash memory
 - larger memory than MSP430
 - slower
- MSP430, TI (Texas Instruments)
 - ▶ 16-bit RISC core
 - ► 8MHz
 - ► 48KB Flash
 - ▶ 10KB RAM
 - several DACs
 - > RT clock
- ▶ 8051 in CC2430 & CC2431, TI (Texas Instruments)
 - ▶ 8-bit MCU
 - ▶ 32/64/128 KB program memory
 - ► 8 KB RAM

- The communication module of a sensor node is called "Radio Transceiver"
- The essentially tasks of transceiver is to "transmit" and "receive" data between a pair of nodes
- Which characteristics of the transceiver should be consider for sensor nodes?
 - Capabilities
 - Energy characteristics
 - Radio performance



- Transceiver characteristics
 - Capabilities
 - Interface to upper layers (most notably to the MAC layer)
 - \Box bit, byte or packet?
 - Supported frequency range?
 - □ Typically, somewhere in 433 MHz 2.4 GHz, ISM band
 - Supported multiple channels?
 - Transmission data rates?
 - Communication range?
 - Energy characteristics
 - Power consumption to send/receive data?
 - Time and energy consumption to change between different states?
 - Supported transmission power control?
 - Power efficiency (which percentage of consumed power is radiated?)

- Radio performance
 - Modulation
 - \Box ASK, FSK, PSK, QPSK...
 - Noise figure: SNR
 - Gain: the ratio of the output signal power to the input power signal
 - Carrier sensing and RSSI characteristics
 - Frequency stability (Ex: towards temperature changes)
 - Voltage range

- Transceivers typically has several different states/modes :
 - **Transmit** mode
 - Transmitting data
 - **Receive** mode
 - Receiving data
 - Idle mode
 - Ready to receive, but not doing so
 - Some functions in hardware can be switched off
 - Reducing energy consumption a little
 - Sleep mode
 - Significant parts of the transceiver are switched off
 - Not able to immediately receive something
 - Recovery time and startup energy in sleep state can be significant

• Example of transceivers are recently used in Senor Node

- RFM TR1000 family
 - ▶ 916 or 868 MHz
 - ▶ 400 kHz bandwidth
 - Up to 115,2 kbps
 - On/off keying or ASK
 - Dynamically tuneable output power
 - Maximum power about 1.4 mW
 - Low power consumption
- Chipcon CC1000
 - Range 300 to 1000 MHz, programmable in 250 Hz steps
 - FSK modulation
 - Provides RSSI

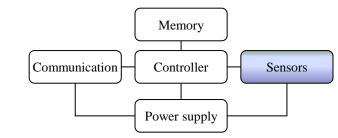
- Chipcon CC 2400
 - Ex: TI CC2420
 - Implements 802.15.4
 - > 2.4 GHz, DSSS modem
 - ▶ 250 kbps
 - Higher power consumption than above transceivers
- Infineon TDA 525x family
 - E.g., 5250: 868 MHz
 - ASK or FSK modulation
 - RSSI, highly efficient power amplifier
 - Intelligent power down, "selfpolling" mechanism
 - Excellent blocking performance

- TI CC 2431
 - ▶ 8051 MCU core
 - ▶ 128KB in-system programmable flash
 - ► 8KB SRAM
 - Powerful DMA
 - One IEEE 802.15.4 MAC timer
 - > 2.4GHz IEEE 802.15.4 compliant RF
 - RX (27mA), TX (27mA), MCU running at 32MHz
 - 0.3uA current consumption in power down mode
 - Wide supply voltage range (2.0V-3.6V)
 - CSMA/CA hardware support
 - Digital RSSI/LQI support
 - ▶ 12-bit ADC with up to eight inputs and configuration resolution
 - Two USARTs with support for several serial protocols
 - 128-bit AES security coprocessor

Main Components of a Sensor Node : Sensing module

Sensor's main categories [1]

- Passive vs. Active
- Directional vs. Omidirectional
- Some sensor examples
 - Passive & Omnidirectional
 - light, thermometer, microphones, hygrometer, ...
 - Passive & Directional
 - electronic compass, gyroscope, ...
 - Passive & Narrow-beam
 - ▶ CCD Camera, triple axis accelerometer, infar sensor ...
 - Active sensors
 - Radar, Ultrasonic, ...



Main Components of a Sensor Node : Sensing module

Example of sensors are integrated with Senor Node



Infar sensor



Ultrasonic



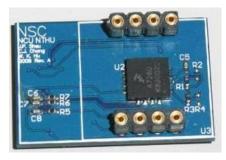
Gyroscope



Electronic compass



Pressure Sensor



Triple axis accelerometer



Temperature and Humidity Sensor

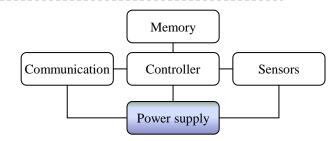
Main Components of a Sensor Node : Power supply module

Power supply module

- provides as much energy as possible
- includes following requirements
 - Longevity (long shelf live)
 - Low self-discharge
 - Voltage stability
 - Smallest cost
 - High capacity/volume
 - Efficient recharging at low current
 - Shorter recharge time

Options of power supply module

- Primary batteries
 - not rechargeable
- Secondary batteries
 - rechargeable
 - ▶ In WSN, recharging may or may not be an option



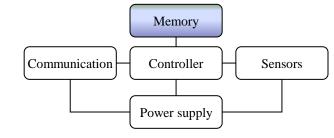
Main Components of a Sensor Node : Power supply module

- Examples of primary and secondary battery [2]
 - Energy per volume : J/cm³ (Joule per cubic centimeter)

Primary batteries			
Chemistry	Zinc-air	Lithium Polymer Cell	Alkaline
Energy (J/cm ³)	3780	2880	1200
Secondary batteries			
Chemistry	Lithium Polymer Cell	Ni-MH	Ni-Cd
Energy (J/cm ³)	1080	860	650

Main Components of a Sensor Node : Memory module

- The memory module of a sensor node has two major tasks
 - To store intermediate sensor readings, packets from other nodes, and so on.
 - To store program code
- For the first task
 - Random Access Memory (RAM) is suitable
 - The advantage of RAM is fast

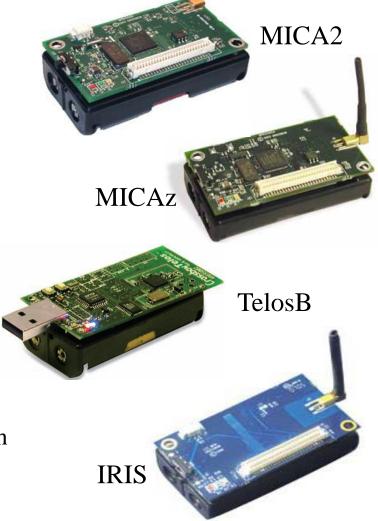


- The main disadvantage is that it loses its content if power supply is interrupted
- For the second task
 - Read-Only Memory (ROM)
 - Electrically Erasable Programmable Read-Only Memory (EEPROM)
 - Flash memory (allowing data to be erased or written in blocks)
 - can also serve as intermediate storage of data in case RAM is insufficient or when the power supply of RAM should be shut down for some time
 - long read and write access delays
 - high required energy

2.2. Introduction of Sensor Hardware Platform

Overview of Sensor Node Platforms

- Some modules developed by U.C. Berkeley & Crossbow Tech.
 - MICA2
 - 8-bit Atmel ATmega128L microcontroller
 - (4 KB SRAM + 128 KB Flash)
 - RF: CC1000 (data rate: 38.4kbits/s)
 - MICAz
 - 8-bit Atmel ATmega128L microcontroller
 - RF: CC2420 (data rate: 250kbits/s)
 - TelosB
 - 16-bit MSP430 microcontroller
 - (10 KB RAM + 48KB Flash) + 1MB Flash
 - RF: CC2420 (data rate: 250kbits/s)
 - ► IRIS
 - 8-bit Atmel ATmega1281 microcontroller
 - (8 KB RAM + 128KB Flash) + 512KB Flash
 - ▶ RF: RF230, data rate: 250kbits/s



Overview of Sensor Node Platforms

- Octopus modules were developed by NTHU
 - Octopus I (Compatible with MICAz)
 - 8-bit Atmel ATmega128L microcontroller
 - RF: CC2420 (data rate: 250kbits/s)
 - Octopus II
 - 16-bit MSP430 microcontroller
 - 10 KB RAM + 48KB Flash) + 1MB Flash
 - RF: CC2420 (data rate: 250kbits/s)
 - Octopus X
 - 8-bit 8051 microcontroller
 - > 128KB in-system programmable flash
 - ► 8KB RAM + 4KB EEPROM
 - ▶ RF: CC2430, EEE 802.15.4 compliant RF transceiver



Octopus I



Octopus II



Octopus X

- Octopus X includes three models
 - Octopus X-A
 - CC2431 + Inverted F Antenna
 - Octopus X-B
 - CC2431 + SMA Type Antenna
 - Octopus X-C

- Octopus X-A Octopus X-B Octopus X-C
- ► CC2431 + Inverted F and SMA Type Antenna + USB interface
- Peripherals of Octopus X
 - Octopus X-USB dongle
 - Octopus X-Sensor board
 - Temperature sensor
 - Gyroscope
 - Three axis accelerometer
 - Electronic Compass



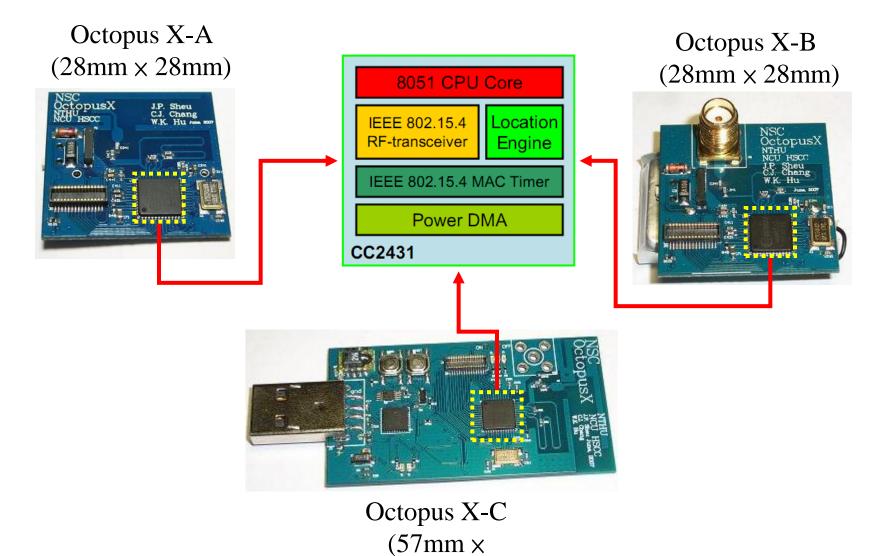
USB dongle



Temperature sensor

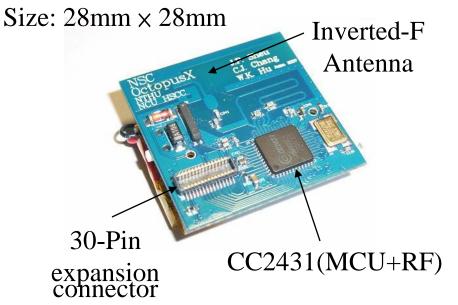


Three axis accelerometer

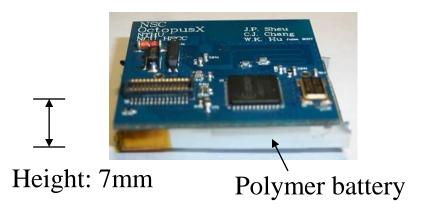


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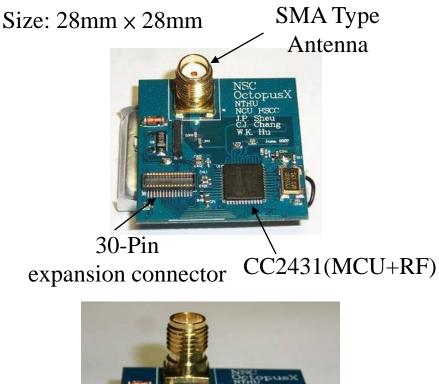
Features of Octopus X-A

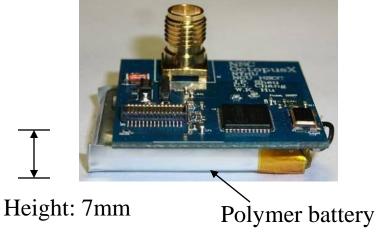


- MCU (CC2431)
- Inverted-F antenna
- RF transmission range \Rightarrow 100m
- External crystal (32MHz+32.768KHz)
- 30-Pin expansion connector
 - Polymer batter (3.7V 300mAh)



Features of Octopus X-B

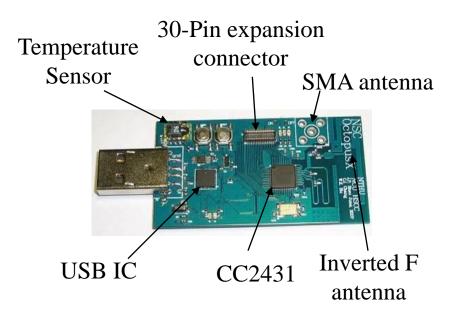




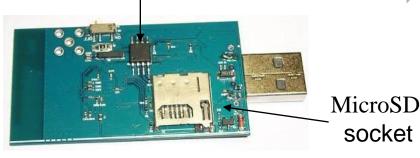
- MCU (CC2431)
- SMA type antenna
- RF transmission range \Rightarrow 150m
- External crystal (32MHz+32.768KHz)
- 30-Pin expansion connector
- Polymer batter (3.7V 300mAh)

Features of Octopus X-C

Size: 57mm × 31mm

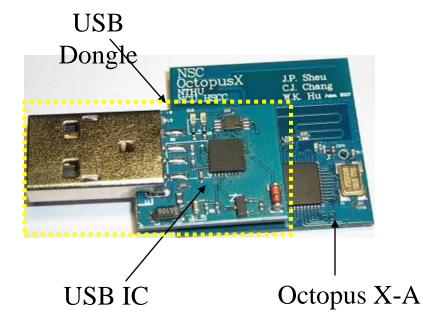


External memory with 2MB



- MCU (CC2431)
- SMA type and Inverted-F antenna
- Humidity & Temperature sensor
 - Humidity 0~100% RH (0.03% RH)
 - ► Temperature -40°C~120°C (0.01°C)
- External flash memory (2MB)
- MicroSD socket (up to 8GB)
- USB Interface
 - Programming
 - Debugging
 - Data collection

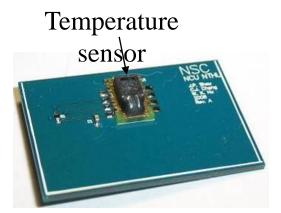
Features of Octopus X - USB Dongle



- Octopus X-USB dongle provides an easy-to-use USB protocol for
 - Programming
 - Debugging
 - Data collections

Features of Octopus X - Sensor Boards

Size: 28mm × 18mm

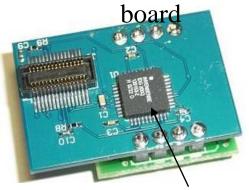


Front view of Octopus X-sensor board



Electronic

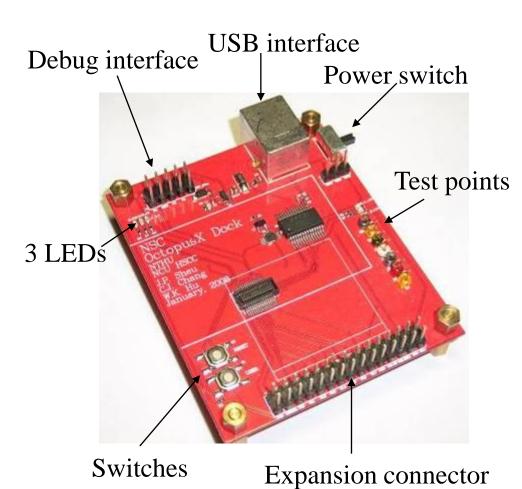
Compass Back view of Octopus X-sensor



Sensor board (Gyroscope + Triple axis accelerometer)

Features of Octopus X - Dock

Size: 60mm × 71mm



USB interface

- Programming with our flash programmer
- Data collections
- Debug interface
 - Programming with TI SmartRF04EB
- 30-Pin expansion connector
- User switch and reset switch
- Test points
- DC power switch
- ► 3 LEDs

Summary of Octopus X

- Octopus X is not only compatible with IAR embedded workbench but also "Keil C " software
- Octopus X is of 2-Layer design to reduce production cost
- Octopus X can be not only programmed from USB interface but also TI programming board
- RF transmission range of Octopus X is up to 150m
- Expansion connector design on Octopus X provides a user interface for sensor boards and dock

- Octopus II includes two models
 - Octopus II-A
 - MSP430F1611 + USB Interface + Inverted F and SMA Type Antenna
 - Octopus II-B
 - Octopus II-A + External Power Amplifier

Peripherals of Octopus II

- Octopus II-Sensor board
 - Temperature sensor
 - Light sensors
 - Gyroscope
 - Three axis accelerometer



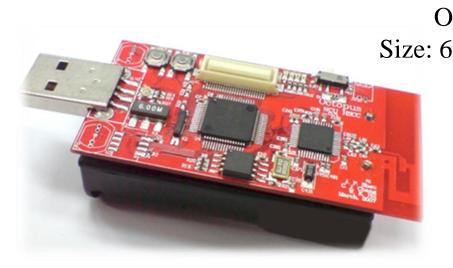


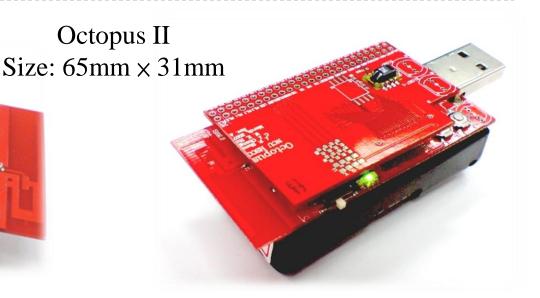
Octopus II-A

Octopus II-B

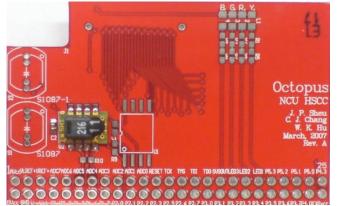


Octopus II-Sensor board



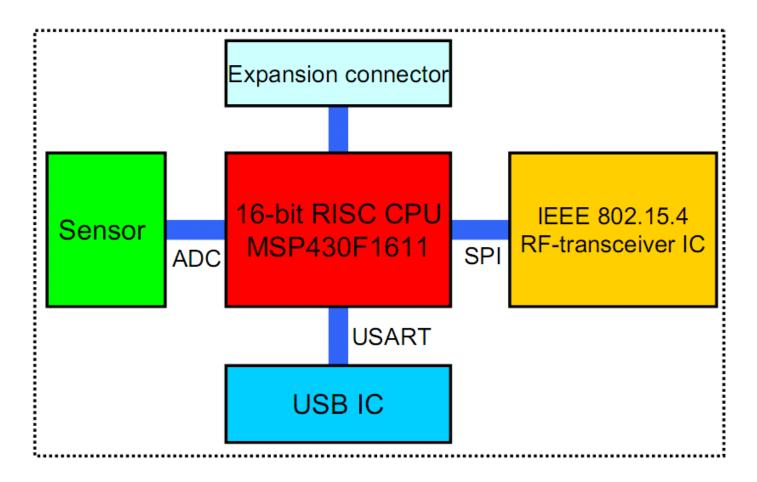


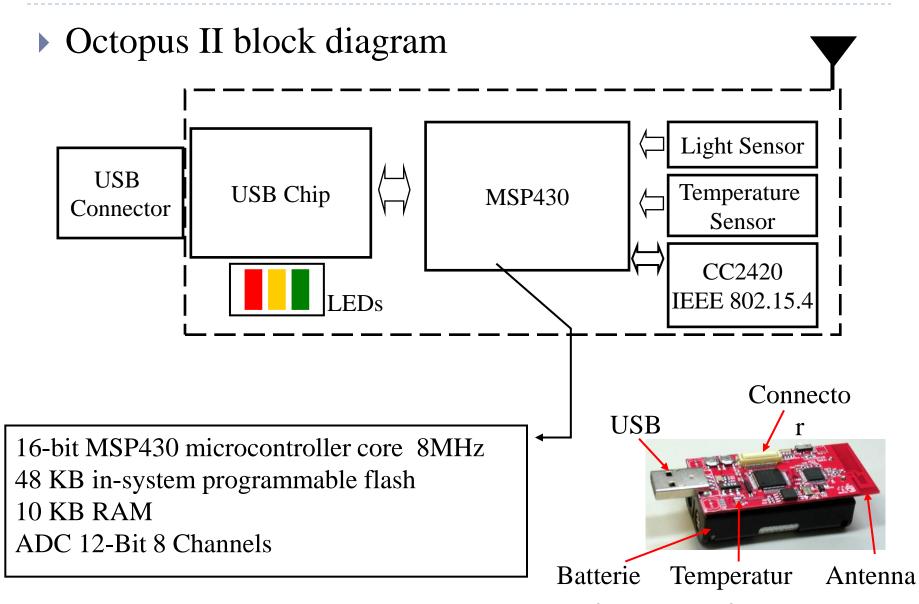
Sensor Board Size: 50mm × 31mm





Octopus II block diagram





Features of Octopus II-A

MCU (MSP430F1611)

- Flash Memory (48 KB + 256 KB)
- RAM (10 KB)
- External Flash (1 MB)
- External Crystal (4 MHz + 32.768 KHz)
- Serial Communication Interface (USART, SPI or I²C)
- Low Supply-Voltage Range (1.8V ~ 3.6V)
- Five Power-Saving Modes
- Sensors
 - Humidity & Temperature sensor
 - Humidity 0 ~ 100%RH (0.03%RH)
 - ► Temperature -40°C ~ 120°C (0.01°C)
 - Light sensors

Features of Octopus II-A

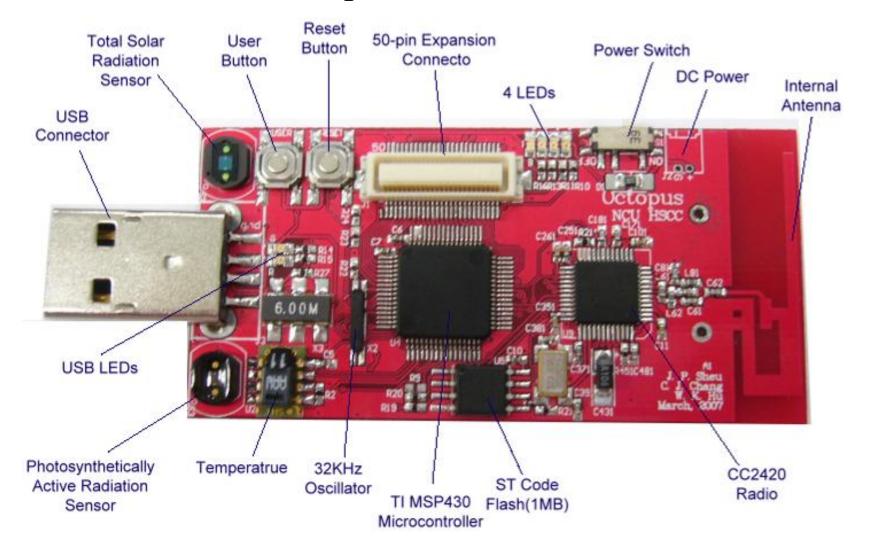
• Radio (CC2420)

- > 2.4GHz IEEE 802.15.4 compliant RF
- Data rate (250 Kbps)
- Rx (18.8 mA), Tx (17.4 mA)
- Programmable output power
- Digital RSSI/LQI support
- Hardware MAC encryption
- Battery monitor
- RF transmission range \Rightarrow 250m
- Serial number ID
- ► 50-Pin expansion connector
- External DC power connector

Features of Octopus II-A

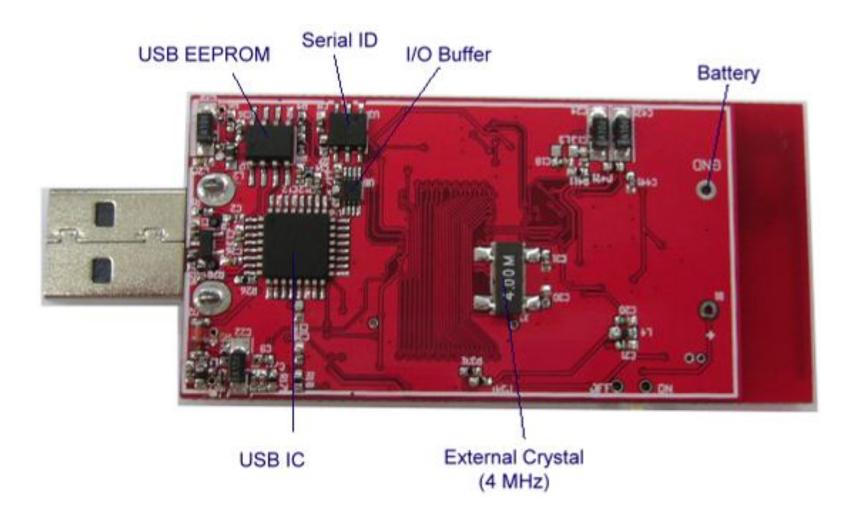
Front view of Octopus II-A

Size: 65mm × 31mm



Features of Octopus II-A

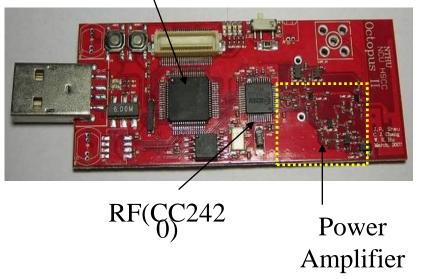
Back view of Octopus II-A



Features of Octopus II-B

Size: 80mm × 31mm

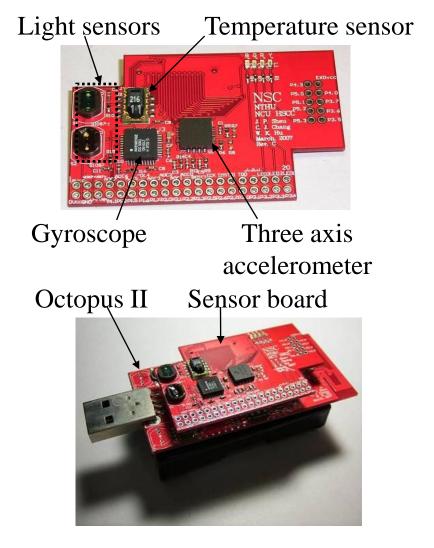
Processor (MSP430F1611)



- RF transmission range ≈ 450 m
- CC2420 with external power amplifier
- Maximum output power: ~10dBm
- Compliance with IEEE 802.15.4 (ZigBee)

Features of Octopus II - Sensor board

Size: 50mm × 31mm

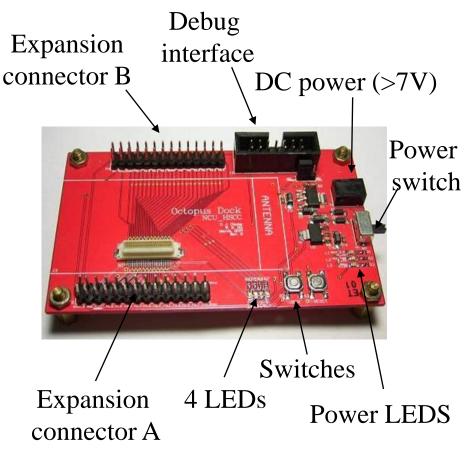


Sensors

- Humidity & Temperature sensor
 - Humidity 0-100%RH (0.03%RH)
 - Temperature -40°C~120°C (0.01°C)
- Light sensors
- Gyroscope
 - Integrated X and Y-axis gyro
- Three axis accelerometer
 - Selectable sensitivity (1.5g/2g/4g/6g)
 - Low current consumption (600uA)
 - Sleep mode (3uA)
 - Low voltage operation (2.2V-3.6V)
 - High sensitivity (800mV/g @ 1.5g)

Features of Octopus II - Dock

Size: 90mm × 54mm



- Easy-to-develop WSN applications
- Debug interface
 - Programming with TI flash programmer
- DC power input
- Power switch
 - 3 power LEDs
- ► 4 user LEDs
- User switch and reset switch
- 2 row expansion connectors

Summary of Octopus II

- Octopus II is not only compatible with TinyOS but also standard C programming
- Octopus II is of 2-Layer design to reduce production cost
- Octopus II can be programmed from USB interface
- Octopus II has two kinds of antennas, SMA type and inverted F type
- RF transmission range of Octopus II is up to 450m
- Expansion connector design on Octopus II provides a user interface for sensor boards and dock

2.3. Energy Consumption of Sensor Node

The Main Consumers of Energy

- Microcontroller
- Radio front ends
 - RF transceiver IC
 - ► RF antenna
- Degree of Memory
 - RAM
 - EEPROM
 - Flash memory

Depending on the type of sensors

- Temperature sensor
- Humidity sensor

Other components

- LED
- External Crystal
- USB IC

Energy consumption of Microcontroller

- A "back of the envelope" estimation for energy consumption
 - It means "energy consumption" is easily to estimate

Number of instructions

- Energy per instruction: 1 *nJ* [4]
- Small battery ("smart dust"): 1 J = 1 Ws
- Corresponds: 10⁹ instructions!

Lifetime

- Require a single day operational lifetime
 = 24hr × 60mins × 60secs = 86400 secs
- ► 1 Ws / 86400s \Rightarrow 11.5 µW as max. sustained power consumption!

Not feasible!

- Most of the time a wireless sensor node has nothing to do
- Hence, it is best to turn it off

Multiple power consumption modes

• Way out: Do not run sensor node at full operation all the time

- If nothing to do, switch to *power safe mode*
- Question: When to throttle down? How to wake up again?

Typical modes

- Microcontroller
 - Active, Idle, Sleep
- Radio mode
 - Turn on/off transmitter/receiver or Both

Multiple modes possible, "deeper" sleep modes

- Strongly depends on hardware
- Ex: TI MSP 430
 - Four different sleep modes
- Atmel ATMega
 - Six different modes

Some Energy Consumption Figures

Microcontroller power consumption

- TI MSP 430 (@ 1 MHz, 3V) [6]
 - Fully operation : 1.2 mW
 - Deepest sleep mode : 0.3 μW
 - □ Only woken up by external interrupts (not even timer is running any more)

Atmel ATMega128L [7]

- Operational mode:
 - \Box Active : 15 mW
 - \Box Idle : 6 mW
- Sleep mode : 75 μ W

Some Energy Consumption Figures

- TI CC2430[8] & 2431 [9]
 - MCU Active Mode, static : 492 μA
 - □ No radio, crystals, or peripherals
 - MCU Active Mode, dynamic : 210µA/MHz
 No radio, crystals, or peripherals
 - MCU Active Mode, highest speed : 7.0 mA
 MCU running at full speed (32MHz)
 - □ No peripherals
 - Power mode 1 : 296µA
 □ RAM retention
 - Power mode 2 : 0.9 µA
 □ RAM retention
 - Power mode 3: 0.6µA
 □ No clocks, RAM retention

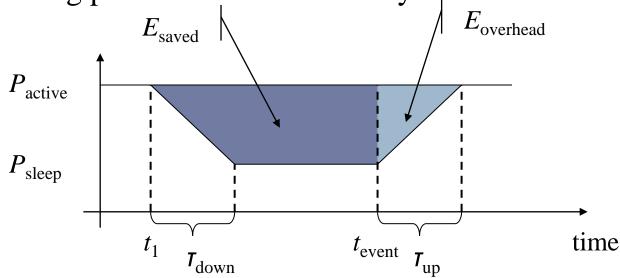
Some Energy Consumption Figures

Memory power consumption

- Power for RAM almost negligible
- FLASH memory is crucial part
- FLASH writing/erasing is expensive
 - Example: FLASH on Mica motes
 - Reading: $\doteq 1.1 \ nAh$ per byte
 - Writing: \Rightarrow 83.3 *nAh* per byte

Switching between Modes

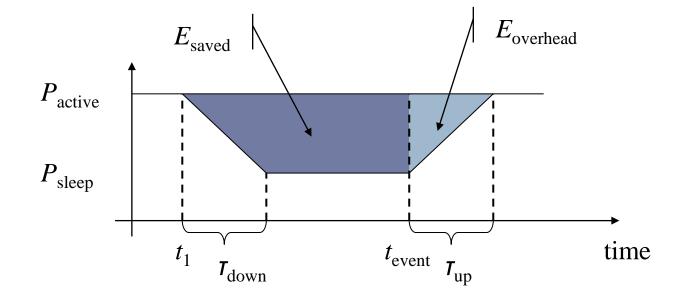
- Simplest idea: Greedily switch to lower mode whenever possible
- Problem: Time and power consumption required to reach higher modes not negligible
 - Introduces overhead
 - Switching only pays off if $E_{\text{saved}} > E_{\text{overhead}}$
- Example: Event-triggered wake up from sleep mode
- Scheduling problem with uncertainty



Switching between Modes

$$E_{\text{saved}} = (t_{\text{event}} - t_1) \times P_{\text{active}} - (\tau_{\text{down}} \times (P_{\text{active}} + P_{\text{sleep}})/2 + (t_{\text{event}} - t_1 - \tau_{\text{down}}) \times P_{\text{sleep}})$$

$$E_{\text{overhead}} = \tau_{\text{up}} \times (P_{\text{active}} + P_{\text{sleep}}) / 2$$



Power Consumption vs. Transmission Distance

Free space loss: direct-path signal

$$P_r = P_t G_r G_t \frac{\lambda^2}{(4\pi)^2 (d)^2} = \frac{A_r A_t}{(\lambda d)^2}$$

- d = distance between transmitter and receiver
- P_t = transmitting power
- P_r = receiving power
- G_t = gain of transmitting antenna
- $G_{\rm r}$ = gain of receiving antenna
- A_t = effective area of transmitting antenna
- A_r = effective area of receiving antenna

Power Consumption vs. Transmission Distance

Two-path model

$$P_r = P_t G_r G_t \left(\frac{h_t h_r}{d^2}\right)^2$$

- h_t and h_r are the height of the transmitter and receiver
- The general form $P_r = P_t G_r G_t \left(\frac{\lambda}{4\pi}\right)^2 \frac{1}{d^{\gamma}}$

> γ is the propagation coefficient that varies 2 ~ 5

Computation vs. Communication Energy Cost

Tradeoff ?

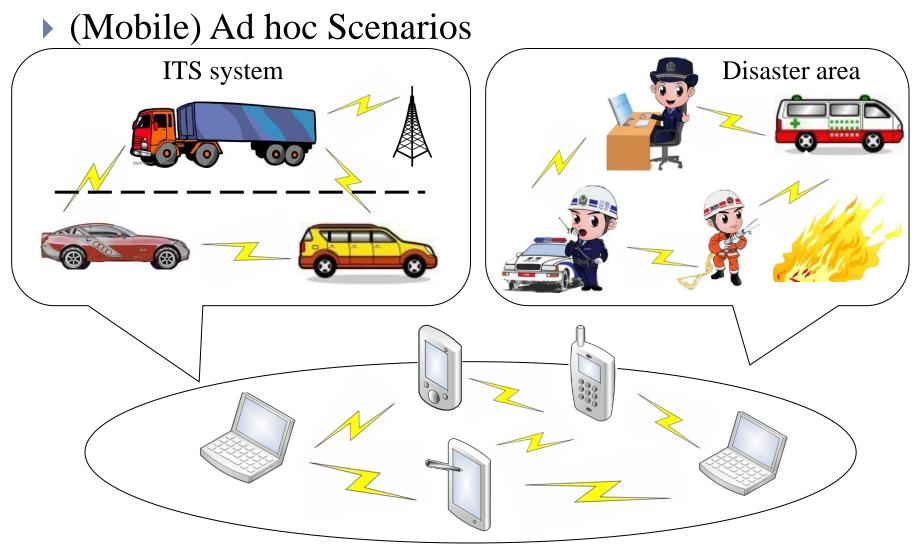
- It's not possible to directly compare computation/communication energy cost
- Energy ratio of "sending one bit" vs. "computing one instruction"
- Communicate (send & receive) 1 KB ≒ Computing 3,000,000 (3 million) instructions [10]

Hence

- Try to compute instead of communicate whenever possible
- Key technique in WSN
 - In-network processing
 - Exploit data centric/aggregation, data compression, intelligent coding, signal processing ...

2.4. Network Architecture

- (Mobile) Ad hoc Scenarios
 - Nodes communicate with each other
 - That means each node can be a source node or destination node
 - Nodes can communicate "some" node in another network
 - Ex: Access to Web/Mail/DNS server on the Internet
 - Typically requires some connection to the fixed network
- Applications of Ad hoc network
 - Traditional data (http, ftp, collaborative apps, ...)
 - Multimedia (voice, video)



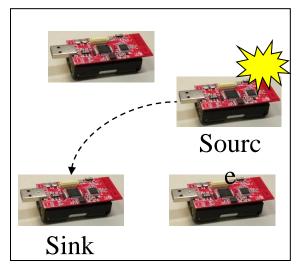
Ad hoc network

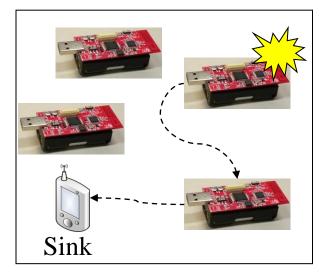
- Sensor Network Scenarios
 - Sources: Any sensor node that provides sensing data/measurements
 - **Sinks**: Sensor nodes where information is required
 - Belongs to the sensor network
 - Could be the same sensor node or an external entity such PDA/NB/Table PC
 - Is part of an external network (e.g., internet), somehow connected to the WSN

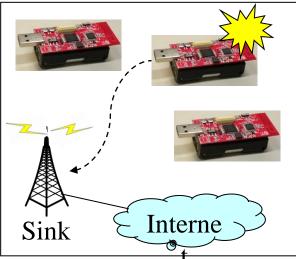
Applications of Sensor Network

- Usually, machine to machine
- Often limited amounts of data
- Different notions of importance

Sensor Network Scenarios



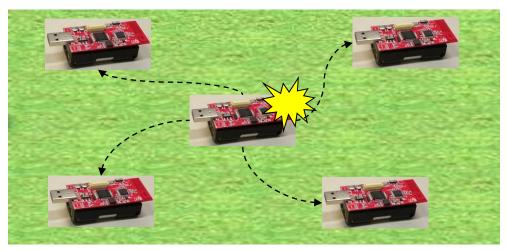




Single-hop vs. Multi-hop Networks

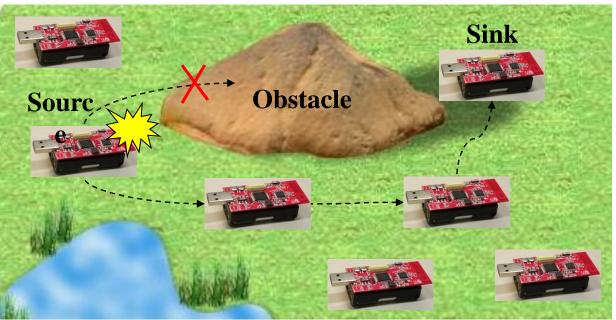
- One common problem: limited range of wireless communication
 - Limited transmission power
 - Path loss
 - Obstacles
- Solution: multi-hop networks
 - Send packets to an intermediate node
 - Intermediate node forwards packet to its destination
 - Store-and-forward multi-hop network
- Basic technique applies to both WSN and MANET
- Note:
 - Store-and-forward multi-hopping NOT the only possible solution
 - Ex: Collaborative networking, Network coding [11] [12]....

Single-hop vs. Multi-hop Networks

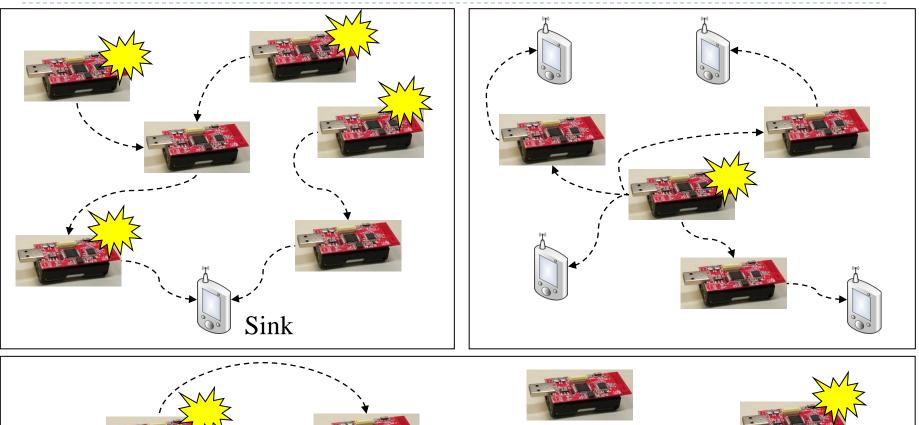


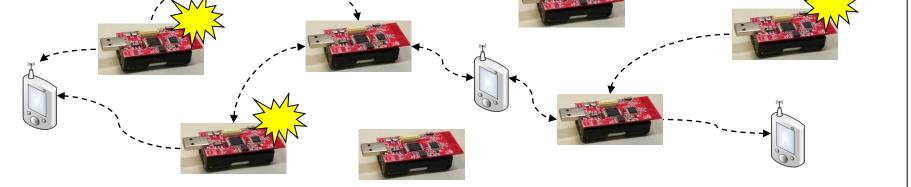
Single-hop networks

Multi-hop networks



Multiple Sinks, Multiple Sources WSN





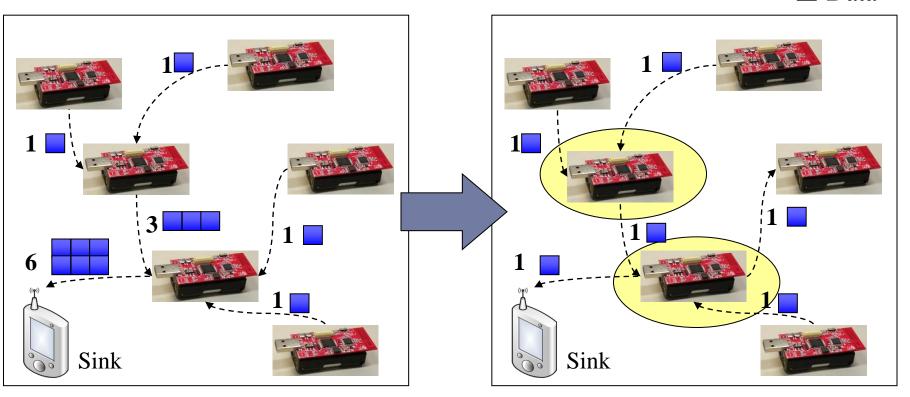
In-network Processing

- MANETs are supposed to deliver bits from one end to the other
- WSNs, on the other end, are expected to provide information, not necessarily original bits
 - Ex: *manipulate* or *process* the data in the network
- Main example: aggregation
 - Apply composable [13] aggregation functions to a convergecast tree in a network
 - > Typical functions: minimum, maximum, average, sum, ...

In-network Processing

Processing Aggregation example

- The simplest in-network processing technique
- Reduce number of transmitted bits/packets by applying an aggregation function in the network
 Data

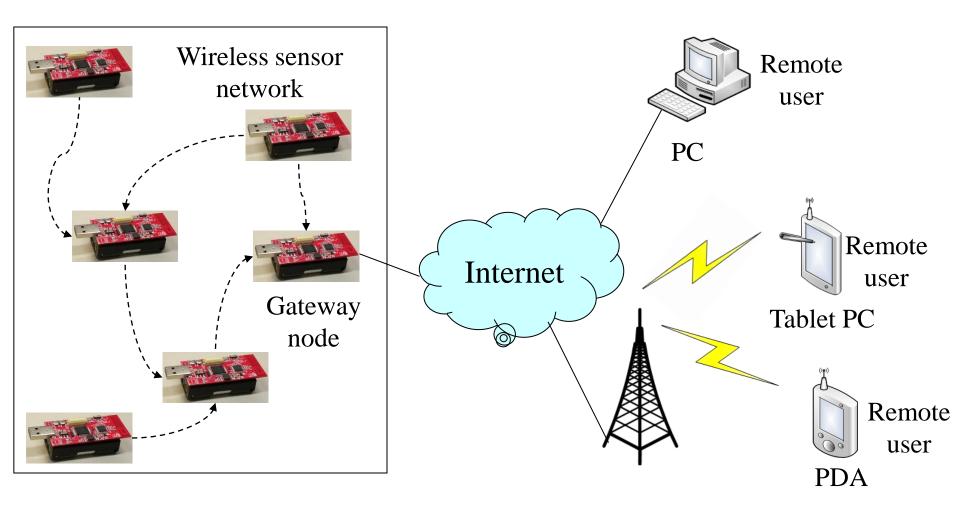


Gateway concepts for WSN/MANET

- Gateways are necessary to the Internet for remote access to/from the WSN
 - For ad hoc networks
 - Additional complications due to mobility
 - □ Ex: Change route to the gateway, use different gateways
 - For WSN
 - Additionally bridge the gap between different interaction semantics in the gateway

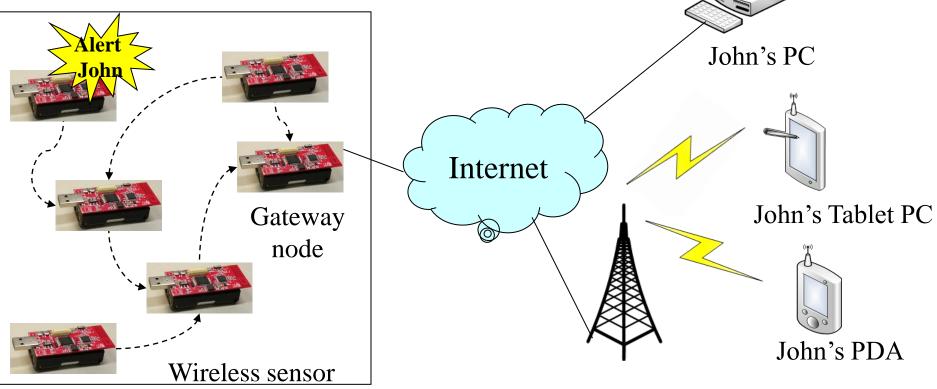
Gateway concepts for WSN/MANET

▶ Gateway support for different radios/protocols, ...



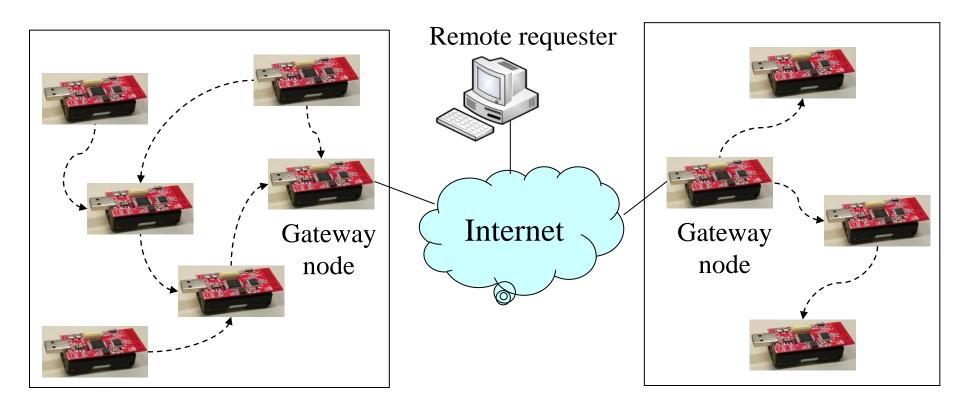
WSN to Internet communication

- Scenario: Deliver an alarm message to an Internet host
- Problems
 - Need to find a gateway (integrates routing & service discovery)
 - Choose "best" gateway if several are available
 - How to find John or John's IP address?



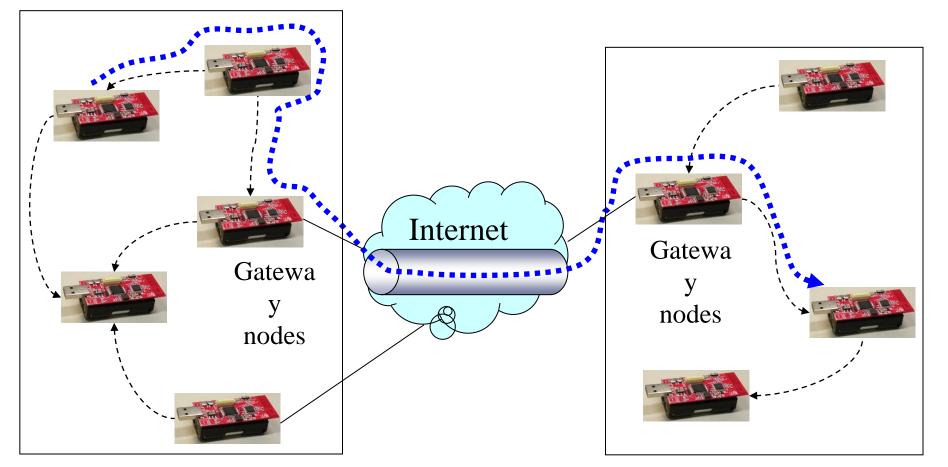
Internet to WSN communication

- How to find the right WSN to answer a need?
- How to translate from IP protocols to WSN protocols, semantics?



WSN tunneling

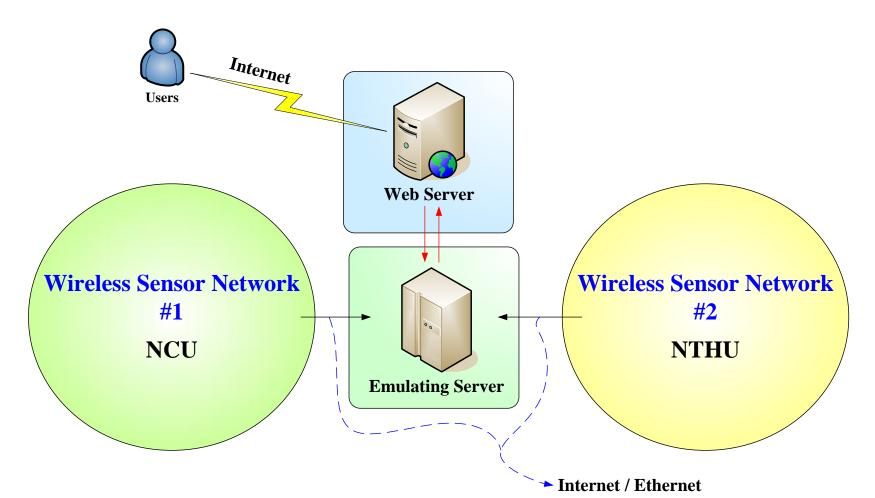
- The idea is to build a larger, "Virtual" WSN
- Use the Internet to "tunnel" WSN packets between two remote WSNs



WSN tunneling

Example of WSN tunneling

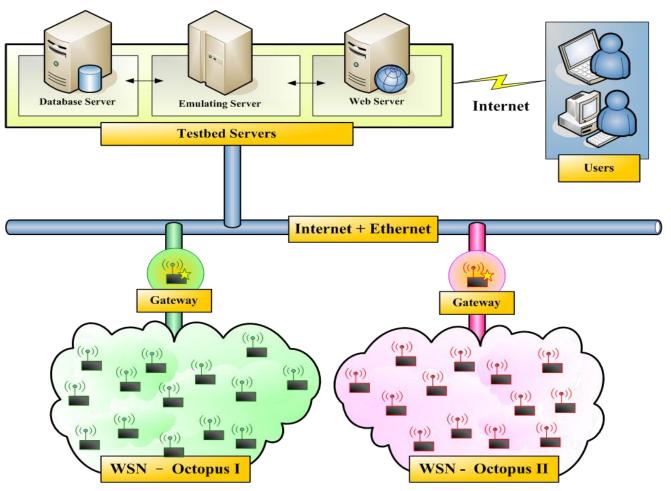
WSNs Testbed



WSN tunneling

Example of WSN tunneling

Testbed scenario



2.5. Challenges of Sensor Nodes

Challenges of Wireless Sensor Node

- More energy-efficient
 - Self-sufficiency in power supply such as the installation of solar collector panels
 - Design more energy-efficient of the circuit, or to adopt more energy-efficient electronic components

Integrating more sensors

• For multiple purposes such as detecting human's motion, temperature, blood pressure and heartbeat at the same time

Higher processing performance

In future, more complex application need more powerful computation

Challenges of Wireless Sensor Node

- More Robust and Secure
 - Not easy damaged or be destroyed
 - Secure transmission of sensing data and not easy being tapped
- Easy to buy and deployment
 - Low price and easy to use

2.6. Summary

Summary

- For WSN, the need to build cheap, low-energy, (small) devices has various consequences for system design
 - Radio frontends and controllers are much simpler than in conventional mobile networks
 - Energy supply and scavenging are still (and for the foreseeable future) a premium resource
 - Power management (switching off or throttling down devices) crucial
- Unique programming challenges of embedded systems
 - Concurrency without support, protection
 - Actual standard: TinyOS

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Recommend Reading

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Network coding

R. Ahlswede, N. Cai, S.-Y. R. Li, and R. W. Yeung. Network Information Flow. *IEEE Transaction on Information Theory*, 46(4): 1204–1216, 2000.

WSN Testbed

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